

Intel® TXN22125 4G FC 1310 nm SFP 10 km Optical Transceiver - SFP* MSA Compatible

Datasheet

The Intel® LC Small-Form Factor Pluggable (SFP) optical transceivers are high-performance integrated modules for bi-directional communication over single-mode optical fiber.

The Intel® TXN22125 4G FC 1310 nm SFP 10 km Optical Transceiver - SFP* MSA Compatible (called hereafter the TXN22125 4G Optical Transceiver) is specifically designed for high-speed Fibre Channel data links at 4.25 Gbps (4x Fibre Channel rate). The TXN22125 4G Optical Transceiver is also backwards compatible with 2x and 1x Fibre Channel and Gigabit Ethernet rates.

The TXN22125 4G Optical Transceiver has an LC receptacle that is compatible with the industry-standard LC connector. The TXN22125 4G Optical Transceiver is Class 1 laser safety compliant with FDA Radiation Performance Standards, 21 CFR 1040.10, and international standards IEC 60825-1 and IEC 60825-2.

- Compliant with the Fibre Channel FC-PI Standard
- 4.25/2.125/1.0625 Gbps Fibre Channel and 1.25 Gbps Ethernet Compatible
- Compatible with the SFP Multisource Agreement (MSA) Specification
- Hot pluggable
- 1310 nm DFB laser-based emitter
- TTL Loss of Signal (LOS) Output
- Transmitter Disable Input
- AC-coupled CML Level Input/Output
- Single +3.3 V Power Supply
- Class 1 Laser Safety Product
- IEC/UL 60950-1 Safety Certified
- Designed and verified as RoHS compliant
- China RoHS compliant with 30-year EFUP
- Digital Diagnostics Support

Applications

- Fibre Channel Switch
- Fibre Channel Host Bus Adapter



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Revision History

Date	Revision	Description
18-April-2007	004	<p>Changes for datasheet for Intel® TXN22125 4G Optical Transceiver -</p> <ul style="list-style-type: none"> - Table 5, "Electrical Characteristics – Receiver" on page 10 - Text changed - Table 6, "Fiber Length Specifications" on page 11 - Text changed - Table 17, "Masking Alarm and Warning Flags Address– 2-Wire Address A2h, Address 136" on page 25 - Text in footnotes changed - Table 18, "Regulatory Compatibility Compliance" on page 27 - Text changed - Added Section 8.3, "Lead-Free Conformance" on page 29 - Added Section 8.5, "Management Methods on Control of Pollution from Electronic Information Products (a.k.a. China RoHS)" on page 30
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02-Sep-2005	001	Initial release of datasheet for Intel® TXN22125 4G Optical Transceiver



Intel® TXN22125 4G FC 1310 nm SFP 10 km Optical Transceiver - SFP MSA Compatible*



1.0 Introduction

The Intel® TXN22125 4G FC 1310 nm SFP 10 km Optical Transceiver - SFP* MSA Compatible [called hereafter the TXN22125 4G Optical Transceiver or "the module(s)"] is specifically designed for high-speed Fibre Channel data links at 4.25 Gbps (4x Fibre Channel rate).

This document discusses the following topics:

- [Chapter 2.0, "Specifications and Characteristics," on page 8](#)
- [Chapter 3.0, "Electrical Interface," on page 13](#)
- [Chapter 4.0, "Termination," on page 15](#)
- [Chapter 5.0, "SFP Timing Parameters," on page 17](#)
- [Chapter 6.0, "Digital Diagnostic Monitoring Interface," on page 18](#)
- [Chapter 7.0, "Mechanical Specifications," on page 26](#)
- [Chapter 8.0, "Regulatory Compliance," on page 27](#)
- [Chapter 9.0, "Ordering Information," on page 32](#)
- [Chapter 10.0, "Acronyms," on page 33](#)

For information on standards that apply to the TXN22125 4G Optical Transceiver, see the following references:

- "Digital Diagnostics Monitoring Interface for Optical Transceivers". SFF Document Number SFF-8472, Revision 9.3.
- IEEE Standard 802.3, 2002 Edition, Clause 38, PMD Type 1000BASE-LX. IEEE Standards Department, 2002
- IEEE Std 802.3z, 1998 Edition. Gigabit Interface Converter (GBIC) Ethernet Standard.
- Small Form-factor Pluggable (SFP) Transceiver Multi-source Agreement (MSA)
- Telcordia Technologies* GR-63 Section 4.2



2.0 Specifications and Characteristics

Specifications and characteristics include the following:

- Section 2.1, “Maximum Ratings and Recommended Operating Conditions” on page 8
- Section 2.2, “Electrical Characteristics” on page 9
- Section 2.3, “Optical Specifications” on page 11

2.1 Maximum Ratings and Recommended Operating Conditions

Table 1 lists the absolute maximum ratings for the TXN22125 4G Optical Transceiver.

Table 1. Absolute Maximum Ratings

Parameter	Symbol	Min	Typ	Max	Units	Notes
Storage Temperature	T_s	-40	–	85	°C	–
Relative Humidity	RH	5	–	95	%	–
Supply Voltage	$V_{cc,T,R}$	-0.5	–	4	V	–
Data AC Voltage	TD+ and TD-	–	–	2.6	Vpp	Differential
Control Input Voltage	V_i	-0.5	–	$V_{cc} + 0.3$	V	–
Caution: Exceeding these values may cause permanent damage. Functional operation under these conditions is not implied.						

Table 2 lists the recommended operating conditions. (Minimum and maximum values listed in Table 3 through Table 8 apply over the recommended operating conditions specified in Table 2.)

Table 2. Recommended Operating Conditions

Parameter	Symbol	Min	Typ	Max	Units
Case Temperature	T_c	-30	–	85	°C
Supply Voltage	$V_{cc,T,R}$	2.97	3.3	3.63	VDC
Data Rate	–	1.0625	–	4.25	Gbps



2.2 Electrical Characteristics

The minimum and maximum values in this section apply over the following recommended temperature and voltage range (from Table 2, "Recommended Operating Conditions" on page 8).

$$-30\text{ }^{\circ}\text{C} < T_c < 85\text{ }^{\circ}\text{C}, 3.0\text{ V} < V_{cc} < 3.6\text{ V}$$

Table 3 lists the TXN22125 4G Optical Transceiver electrical characteristics for power and current.

Table 3. Electrical Characteristics – Power and Current

Parameter	Symbol	Min	Typ	Max	Units	Notes
Supply Current	I_{cc}	–	170	200	mA	$T_c = 25^{\circ}\text{C}$, $V_{cc} = 3.3\text{ V}$
			–	250	mA	$-30^{\circ}\text{C} < T_c < 85^{\circ}\text{C}$, $2.97\text{ V} < V_{cc} < 3.63\text{ V}$
Power Dissipation	P_{diss}	–	450	910	mW	$-30^{\circ}\text{C} < T_c < 85^{\circ}\text{C}$, $2.97\text{ V} < V_{cc} < 3.63\text{ V}$
Supply Noise Rejection	–	100	–	–	mV	10 kHz to 4 MHz with supply filter
Inrush Current	–	–	–	30	mA	Hot plugging of the TXN22125 4G Optical Transceiver results in the inrush current of no more than 30 mA greater than the steady state value.

Table 4 lists the TXN22125 4G Optical Transceiver transmitter electrical characteristics.

Table 4. Electrical Characteristics – Transmitter

Parameter	Symbol	Min	Typ	Max	Units	Notes
CML Input (Single Ended)	–	250	–	1100	mVpp	AC Coupled Inputs
CML Input (Differential)	–	500	–	2200	mVpp	Peak-to-peak voltage
Input Impedance (Differential)	Z_{IN}	85	100	115	Ω	–
TX_DISABLE input voltage - High	V_{IH}	2	–	$V_{cc} + 0.3$	V	–
TX_DISABLE input voltage - Low	V_{IL}	0	–	0.8	V	–
TX_Fault Output Voltage - High	V_{OH}	2.0	–	$V_{cc} + 0.3$	V	$I_{OH} = 40\text{ }\mu\text{A}$, 1 TTL Unit Load
TX_Fault Output Voltage - Low	V_{OL}	0	–	0.8	V	$I_{OL} = -1.6\text{ mA}$, 1 TTL Unit Load



Table 5 lists the TXN22125 4G Optical Transceiver receiver electrical characteristics.

Table 5. Electrical Characteristics – Receiver

Parameter	Symbol	Min	Typ	Max	Units	Notes
CML Output (Single Ended)	–	250	300	500	mVpp	AC-coupled outputs
CML Output (Differential)	–	500	600	1000	mVpp	Peak-to-peak voltage
CML Output (Rise/Fall Time)	–	–	–	90	ps	20% - 80%
Output Impedance (Differential)	Zout	85	100	115	Ω	–
TTL Loss of Signal (LOS) Output - Low	–	0	–	0.8	V	I _{OL} = -1.6 mA, 1 TTL Unit Load
TTL LOS Output - High	V _{OH}	2.0	–	V _{CC} + 0.3	V	I _{OL} = 40 μA, 1 TTL Unit Load
Deterministic Jitter	DJ			25	ps	–
Total Jitter	TJ	–	–	62	ps	–
MOD_DEF (0:2)	V _{OH}	2.5	–	V _{CC} + 0.3	V	With Serial ID
	V _{OL}	0	–	0.5	V	–
	NC	100 k	–	–	Ω	Measured to RGND/ TGND



2.3 Optical Specifications

Table 6 lists the TXN22125 4G Optical Transceiver fiber length specifications.

Table 6. Fiber Length Specifications

Parameter	Symbol	Min	Typ	Max	Units	Notes
Data rate	BR		1.0625, 1.25, 2.125, 4.25		Gbps	1
Bit Error Rate	BER			10 ⁻¹²		5
9 μm SMF	L	2	–	10,000 10,000 10,000	m	2 3 4
NOTES:						
1. 1000BASE-LX compatible per IEEE802.3 and 1x, 2x, and 4x Fibre Channel compatible per FC-PI-2						
2. Data rates at 1000BASE-LX Gigabit Ethernet and 1.0625 Gbps						
3. Data rates at 2.125 Gbps Fibre Channel.						
4. Data rate at 4.25 Gbps Fibre Channel.						
5. Data rate at 4.25 Gbps with 2 ⁷ - 1 PRBS pattern.						

Table 7 lists the TXN22125 4G Optical Transceiver transmitter optical specifications.

Table 7. Optical Specifications – Transmitter

Parameter	Symbol	Min	Typ	Max	Units	Notes
Optical Transmit Power	Popt	-8	-4.5	-2.0	dBm	Average launch power
Optical Center		1270	1310	1355	nm	–
Spectral Width	–	–	–	1	nm	RMS
Optical Modulation Amplitude	OMA	200	–	–	μW	pk-pk
Relative Intensity Noise	RIN	–	–	-118	dB/Hz	–
Deterministic Jitter	DJ			30	ps	–
Total Jitter	TJ	–	–	65	ps	–
Output Rise/Fall Time	tR/tF	–	–	90	ps	20 - 80% values, measured unfiltered
Eye Mask: Compliant with eye mask requirements of Fibre Channel – Physical Interfaces (FC-PI-2) specifications. IEEE 802.3z* Gigabit Ethernet 1000 BASE-LX standard.						



Table 8 lists the TXN22125 4G Optical Transceiver receiver optical specifications.

Table 8. Optical Specifications – Receiver

Parameter	Symbol	Min	Typ	Max	Units	Notes
Optical Input Wavelength	–	1270	–	1355	nm	–
Receiver Sensitivity	Pr	-16	-18	–	dBm	4.25 Gbps Test conditions: <ul style="list-style-type: none"> • T_c = 25°C • V_{CC} = 3.3 V • 10⁻¹² BER • 5.5 dB ER input • 2⁷ - 1 PRBS
Stressed Sensitivity	Meets the minimum IEEE 802.3z Gigabit Ethernet 1000 BASE-LX standard.					
Receiver Overload	–	–	–	0	dBm	–
Optical Return Loss	ORL	12	–	–	dB	–
LOS - Asserted	Pa	-29	–	–	dB	Measured on transition - low to high
LOS - De-asserted	Pd	–	–	-18	dBm	Measured on transition - high to low
LOS - Hysteresis	Pa - Pd	1	–	5	dB	–



3.0 Electrical Interface

Figure 1 shows the TXN22125 4G Optical Transceiver electrical interface pin numbers and names.

Figure 1. Electrical Interface Pin Numbers and Names

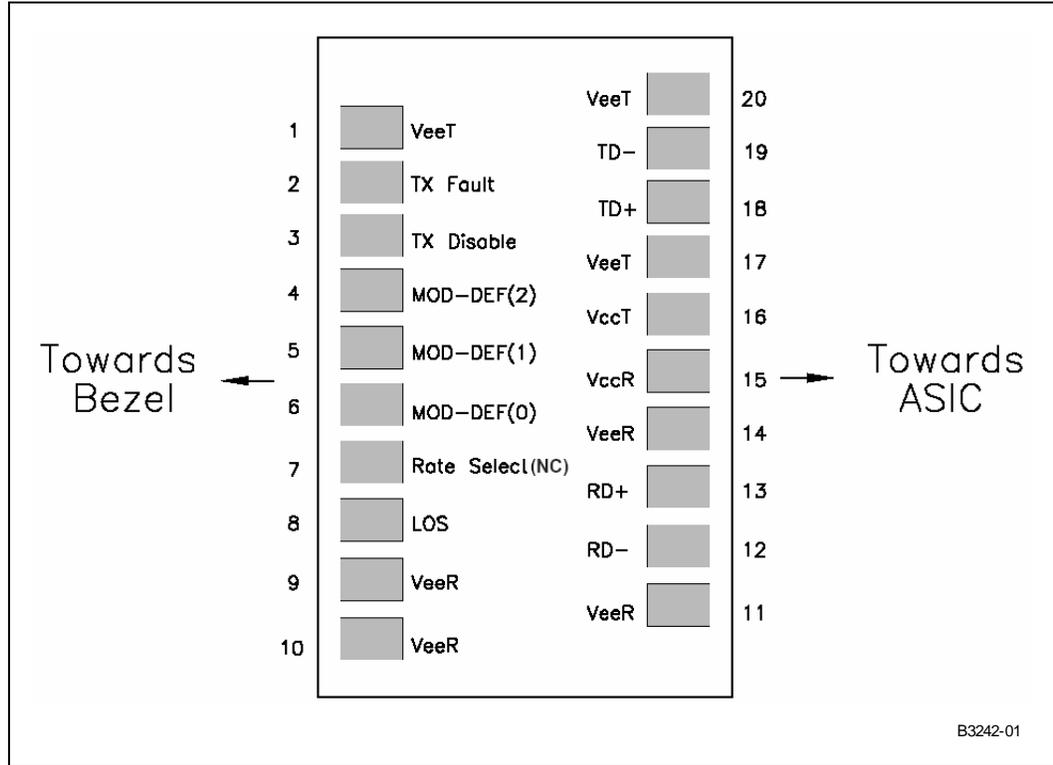


Table 9 lists the plug sequence to follow during hot plugging, as well as pin functions.

Table 9. Plug Sequence: Pin Engagement Sequence During Hot Plugging (Sheet 1 of 2)

Pin Number	Name	Function	Plug Sequence	Notes
1	V _{eeT}	Transmitter Ground	1	–
2	TX_FAULT	Transmitter Fault Indication	3	Note 1
3	TX_DISABLE	Transmitter Disable	3	Note 2: Transmitter disables on high or open
4	MOD_DEF (2)	Module Definition 2	3	Note 3: Wire Serial ID interface
5	MOD_DEF (1)	Module Definition 1	3	Note 3: Wire Serial ID interface
6	MOD_DEF (0)	Module Definition 0	3	Note 3: Ground
7	RATE_SELECT	–	3	Note 4
8	LOS	Loss of Signal	3	Note 5
9	V _{eeR}	Receiver Ground	1	–
10	V _{eeR}	Receiver Ground	1	–
11	V _{eeR}	Receiver Ground	1	–



Table 9. Plug Sequence: Pin Engagement Sequence During Hot Plugging (Sheet 2 of 2)

Pin Number	Name	Function	Plug Sequence	Notes
12	RD-	Inverted Received Data out	3	Note 6
13	RD+	Non-Inverted Received Data out	3	Note 6
14	V _{ee} R	Receiver Ground	1	–
15	V _{cc} R	Receiver Power	2	Note 7
16	V _{cc} T	Transmitter Power	2	Note 7
17	V _{ee} T	Transmitter Ground	1	–
18	TD+	Non-inverted Data In	3	Note 8
19	TD-	Inverted Data In	3	Note 8
20	V _{ee} T	Transmitter Ground	1	–

NOTES:

- TX FAULT** is an open collector/drain output that is pulled up with a 4.7 K - 10 kW resistor on the host board. Use a pull-up voltage between 2.0 V and V_{cc}T, R+0.3 V.
 - Low: Indicates normal operation. In the low state, the output is pulled to < 0.8 V.
 - High: Indicates a laser fault.
- TX DISABLE** is an input used to shut down the transmitter optical output. It is pulled up within the TXN22125 4G Optical Transceiver with a 4.7 K - 10 kW resistor. The states are as follows:
 - Low (0 - 0.8 V): Transmitter Enabled
 - (>0.8, <2.0 V): Undefined
 - High (2.0 - 3.465 V): Transmitter Disabled
- MOD-DEF 0, 1, 2:** These pins are definition pins for the TXN22125 4G Optical Transceiver. They are pulled up with a 4.7 - 10 kW resistor on the host board. Use a pull-up voltage between 2.0 V and V_{cc}T, R+0.3 V.
 - MOD-DEF 0 is grounded by the TXN22125 4G Optical Transceiver to indicate that the TXN22125 4G Optical Transceiver is present.
 - MOD-DEF 1 is the clock line of a two-wire serial interface for serial ID.
 - MOD-DEF 2 is the data line of a two-wire serial interface for serial ID.
- RATE SELECT:** This signal function is not implemented in the TXN22125 4G Optical Transceiver. The TXN22125 4G Optical Transceiver is rate agile – that is, it meets the specifications for 1.0625 Gbps to 4 Gbps data rates without the use of a rate-select pin.
- LOS** (Loss of Signal) is an open collector output that must be connected to V_{cc}R with an external 4.7K – 10kW pull-up resistor.
 - When low, this output indicates normal operation. In the low state, the output is pulled to < 0.8V.
 - When high, this output indicates the received optical power is below the worst-case receiver sensitivity (as defined by the standard in use).
- RD-/+** are the differential receiver outputs. They are AC-coupled 100W differential lines that are terminated with 100W (differential) at the user SerDes. The AC coupling is performed inside the TXN22125 4G Optical Transceiver and is therefore not required on the host board.
- V_{cc}R and V_{cc}T** are the receiver and transmitter power supplies. Their values, which are listed in Table 2, “Recommended Operating Conditions” on page 8, are defined at the SFP connector pin. Maximum supply current is listed in Table 3, “Electrical Characteristics – Power and Current” on page 9. Hot plugging of the TXN22125 4G Optical Transceiver results in the inrush current listed in Table 3, “Electrical Characteristics – Power and Current” on page 9.
- TD-/+** are the differential transmitter inputs. They are AC-coupled differential lines with 100 W differential termination inside the TXN22125 4G Optical Transceiver. The AC coupling is performed inside the TXN22125 4G Optical Transceiver and is therefore not required on the host board.



4.0 Termination

4.1 Types of I/O Interfaces

The TXN22125 4G Optical Transceiver has the following types of I/O interfaces:

- CML Interface
- TTL Interface

High-speed I/Os use the CML interface, while control signals use the TTL interface. Proper termination of I/Os is required for good signal integrity. If I/Os (particularly the CML I/Os) are not terminated properly, then jitter increases significantly due to reflection from impedance mismatches.

4.2 CML Termination

Figure 2 shows a circuit diagram for the CML termination for the TXN22125 4G Optical Transceiver receiver output. The TXN22125 4G Optical Transceiver has built-in AC-coupling capacitors, which help prevent a direct current path from the TXN22125 4G Optical Transceiver power supply to the SerDes input. (A direct current path could damage the ESD diodes on the SerDes.)

- **Internal termination.** For the TXN22125 4G Optical Transceiver receiver output, the SerDes interface provides an internal termination resistor.
- **External termination.** For the proper external termination of the SerDes interface, refer to the SerDes specification.

Figure 2. Circuit Diagram for CML Termination on Receiver Output

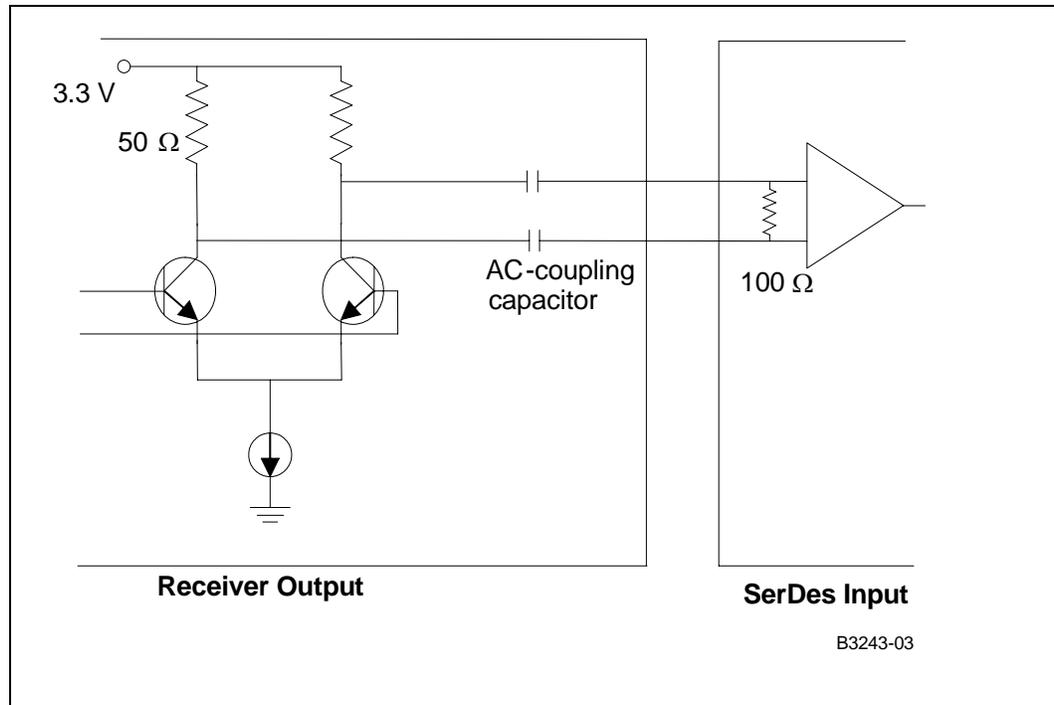
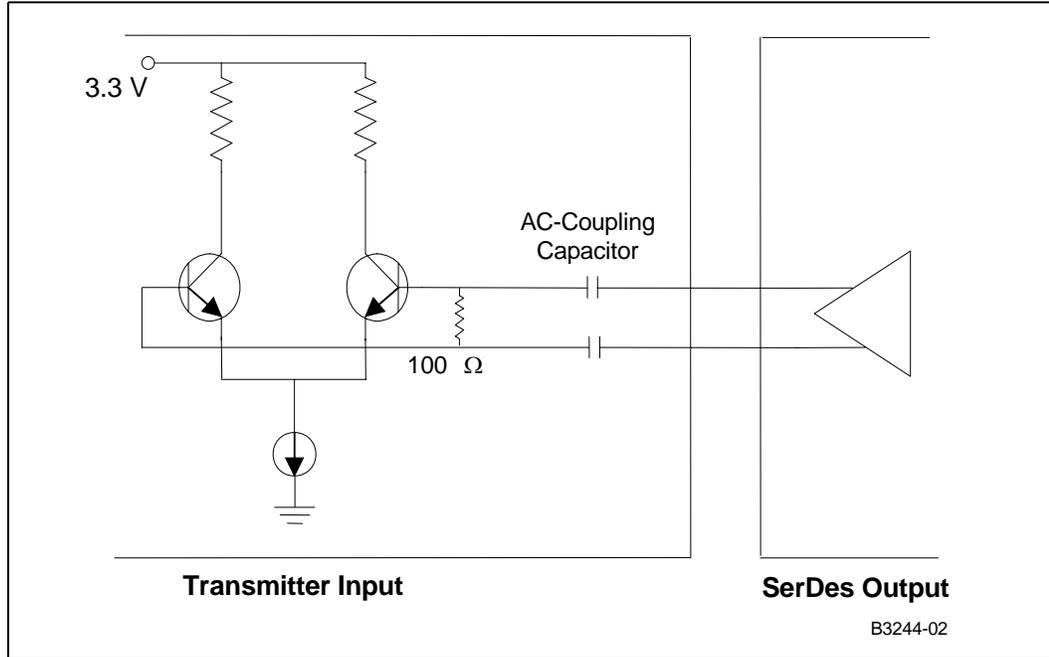




Figure 3 shows a circuit diagram for the CML termination for the TXN22125 4G Optical Transceiver transmitter input.

Internal termination. The TXN22125 4G Optical Transceiver transmitter input has an internal $100\ \Omega$ termination between two inputs. AC-coupling capacitors are also built into the TXN22125 4G Optical Transceiver.

Figure 3. Circuit Diagram for CML Termination on Transmitter Input





5.0 SFP Timing Parameters

Table 10 lists the timing parameters for SFP management.

Table 10. Timing Parameters for SFP Management

Parameter	Symbol	Min.	Max.	Unit	Conditions
TX_DISABLE assert time	t _{off}	–	10	μs	Time from rising edge of TX_DISABLE to when the optical output falls below 10% of nominal
TX_DISABLE negate time	t _{on}	–	1	ms	Time from falling edge of TX_DISABLE to when the modulated optical output rises above 90% of nominal
Time to initialize includes reset of TX_FAULT	t _{init}	–	300	ms	Time from power on or negation of TX_FAULT using TX_DISABLE
TX_FAULT Assert Time	t _{fault}	–	100	μs	Time from fault to TX_FAULT ON
TX Disable to reset	t _{reset}	10		μs	Time TX Disable must be held high to reset TX_FAULT
RX_LOS Assert time	t _{loss_on}	–	100	μs	Time from LOS state to RX_LOS assert
RX_LOS De-assert time	t _{loss_off}	–	100	μs	Time from non-LOS state to RX_LOS de-assert
Rate-Select Change time	t _{ratesel}	–	10	μs	Time from rising or falling edge of Rate Select input until receiver bandwidth is in conformance with appropriate specification
Serial ID Clock Rate	f _{serial_clock}	–	100	kHz	–



6.0 Digital Diagnostic Monitoring Interface

This section includes the following topics:

- [Section 6.1, “Overview of Digital Diagnostic Monitoring Interface” on page 18](#)
- [Section 6.2, “General Memory Map Descriptions” on page 19](#)
- [Section 6.3, “Alarm and Warning Fields for 2-Wire Interface Address A2h” on page 20](#)
- [Section 6.4, “A/D Fields for 2-Wire Interface Address A2h” on page 22](#)

6.1 Overview of Digital Diagnostic Monitoring Interface

The TXN22125 4G Optical Transceiver supports the 2-wire serial communication protocol. The TXN22125 4G Optical Transceiver has a digital diagnostic monitoring interface that is an extension of the serial ID interface defined in the Gigabit Interface Converter (GBIC) specification and the SFP Transceiver MultiSource Agreement (MSA) referenced in [Section 1.0, “Introduction” on page 7](#).

Standard SFP serial ID interface. The standard SFP serial ID interface (the memory map for which is in [Table 11, “Memory Map – 2-Wire Address Range Descriptions” on page 19](#)) provides access to identification information using the 8-bit address 1010000X (A0h). The serial identification information describes information such as the following for the TXN22125 4G Optical Transceiver: capabilities, standard interfaces, and manufacturer information.

Digital diagnostic monitoring interface. The digital diagnostic monitor interface (the memory map for which is in [Table 11, “Memory Map – 2-Wire Address Range Descriptions” on page 19](#)) is an extension of the standard serial ID interface. This interface, which uses the 8-bit address 1010001X (A2h) reserved for optical transceivers, allows real-time access to device-operating parameters while leaving unchanged the original serial ID memory map A0h. The digital diagnostic monitoring interface is backward compatible with both the GBIC specification and the SFP MSA.

For details on the 2-wire addresses A0h and A2h, refer to the SFF-8472 document referenced in [Section 1.0, “Introduction” on page 7](#).



6.2 General Memory Map Descriptions

Table 11 lists descriptions of address ranges for the serial ID memory map.

- The 2-wire address A0h contains serial ID information defined by the SFP MSA.
- The 2-wire address A2h contains data related to the digital diagnostics, defined by the SFF-8472 document referenced in [Section 1.0, "Introduction" on page 7](#).

Table 11. Memory Map – 2-Wire Address Range Descriptions

2-Wire Address 1010000X (A0h)		2-Wire Address 1010001X (A2h)	
Address Range	Address Range Description (Standard Serial ID Information)	Address Range	Address Range Description (Digital Diagnostics Information)
0-95	Serial ID Defined SFP MSA (96 bytes)	0-39	Alarm and Warning (40 bytes) For details, see Table 12, "Alarm and Warning Fields – 2-Wire Address 1010001X (0XA2), Addresses 0-95" on page 20 .
		40-95	Vendor Specific / Calibration Constants (56 bytes) For details, see Table 12, "Alarm and Warning Fields – 2-Wire Address 1010001X (0XA2), Addresses 0-95" on page 20 .
96-127	Vendor Specific (32 bytes)	96-119	Real Time Digital Diagnostics Interface (24 bytes) For details, see the following: <ul style="list-style-type: none"> • Table 13, "A/D Fields – 2-Wire Address 1010001X (0XA2), Addresses 96-109" on page 22 • Table 14, "A/D Status/Control Bits – 2-Wire Address 1010001X (0XA2), Address 110" on page 22 • Table 15, "Alarm Flags Address – 2-Wire Address 1010001X (0XA2), Addresses 112 and 113" on page 23 • Table 16, "Warning Flags Address – 2-Wire Address 1010001X (0XA2) Addresses 116 and 117" on page 24
		120-127	Vendor Specific (8 bytes)
128-255	Reserved in SFP MSA (128 bytes)	128-247	User Writable EEPROM (120 bytes) For details, see the following: <ul style="list-style-type: none"> • Table 17, "Masking Alarm and Warning Flags Address– 2-Wire Address A2h, Address 136" on page 25
		248-255	Vendor Specific (8 bytes)



6.3 Alarm and Warning Fields for 2-Wire Interface Address A2h

Table 12 is a more detailed memory map of the 2-wire interface address A2h for the Alarm and Warning fields, address range 0 to 95.

Table 12. Alarm and Warning Fields – 2-Wire Address 1010001X (0XA2), Addresses 0-95 (Sheet 1 of 2)

Data Address	Field Size (Bytes)	Field Name	Field Description
Base ID Fields			
0	1	Temperature High Alarm	MSB at low address
1	1	LSB	MSB at low address
2	1	Temperature Low Alarm	MSB at low address
3	1	LSB	MSB at low address
4	1	Temperature High Warning	MSB at low address
5	1	LSB	MSB at low address
6	1	Temperature Low Warning	MSB at low address
7	1	LSB	MSB at low address
8	1	Vcc High Alarm	MSB at low address
9	1	LSB	MSB at low address
10	1	Vcc Low Alarm	MSB at low address
11	1	LSB	MSB at low address
12	1	Vcc High Warning	MSB at low address
13	1	LSB	MSB at low address
14	1	Vcc Low Warning	MSB at low address
15	1	LSB	MSB at low address
16	1	Bias High Alarm	MSB at low address
17	1	LSB	MSB at low address
18	1	Bias Low Alarm	MSB at low address
19	1	LSB	MSB at low address
20	1	Tx Bias High Warning	MSB at low address
21	1	LSB	MSB at low address
22	1	Tx Bias Low Warning	MSB at low address
23	1	LSB	MSB at low address
24	1	Tx Power High Alarm	MSB at low address
25	1	LSB	MSB at low address
26	1	Tx Power Low Alarm	MSB at low address
27	1	LSB	MSB at low address
28	1	Tx Power High Warning	MSB at low address
29	1	LSB	MSB at low address
30	1	Tx Power Low Warning	MSB at low address
31	1	LSB	MSB at low address



Table 12. Alarm and Warning Fields – 2-Wire Address 1010001X (0XA2), Addresses 0-95 (Sheet 2 of 2)

Data Address	Field Size (Bytes)	Field Name	Field Description
32	1	Rx Power High Alarm	MSB at low address
33	1	LSB	MSB at low address
34	1	Rx Power Low Alarm	MSB at low address
35	1	LSB	MSB at low address
36	1	Rx Power High Warning	MSB at low address
37	1	LSB	MSB at low address
38	1	Rx Power Low Warning	MSB at low address
39	1	LSB	MSB at low address
40-55	16	Vendor-Specific	–
56-95	40	Calibration Constants	–



6.4 A/D Fields for 2-Wire Interface Address A2h

Table 13 lists descriptions of the analog-to-digital (A/D) fields for the 2-wire interface address A2h, data addresses 96 to 109.

Table 13. A/D Fields – 2-Wire Address 1010001X (0XA2), Addresses 96-109

Data Address	Field Size (Bytes)	Field Name	Field Description
96	1	Temperature MSB	Signed 2's complement integer °C (-40 °C to +125 °C). Based on internal temperature measurement.
97	1	Temperature LSB	Fractional part of temperature (count/256)
98	1	Vcc MSB	Internally measured supply voltage in transceiver. Voltage reading is full 16-bit value × 100 µVolt, which yields a range of 0 to 6.55 V.
99	1	Vcc LSB	
100	1	TX Bias MSB	Measured Laser Bias Current is in mA. Bias current is full 16-bit value × 2 µA, which yields a range of 0 to +131 mA.
101	1	TX Bias LSB	
102	1	TX power MSB	Measured TX output power is in mW. TX power is full 16-bit value × 0.1 µW, which yields a range of -40 to +8.2 dBm.
103	1	TX power LSB	
104	1	RX Power MSB	Measured RX input power is in mW. RX power is full 16-bit value × 0.1 µW, which yields a range of -40 to +8.2 dBm.
105	1	RX Power LSB	
106-109	4	Reserved	–

Table 14 lists descriptions of the A/D status/control bits for the 2-wire interface address A2h, data address 110.

Table 14. A/D Status/Control Bits – 2-Wire Address 1010001X (0XA2), Address 110

Data Address	Bit	Bit Name	Bit Description
110	7	TX Disable State	Soft TX Disable status
110	6	Soft TX Disable	Read/write bit that allows software disable of laser. Writing '1' disables laser.
110	5	Reserved	–
110	4	RX Rate Select State	Not implemented
110	3	Soft RX Rate Select	Not implemented
110	2	Tx Fault	Digital State of Tx Fault Output
110	1	LOS	Digital State of LOS
110	0	Data Ready Bar	Indicates the TXN22125 4G Optical Transceiver has achieved power up and is ready. Note: Ready = '0'.



6.5 Alarm and Warning Flags Fields for 2-Wire Interface Address A2h

Table 15 lists descriptions of the Alarm Flag bits for the 2-wire interface address A2h, data address 112 and 113.

Table 15. Alarm Flags Address – 2-Wire Address 1010001X (OXA2), Addresses 112 and 113

Data Address	Bit	Bit Name	Bit Description
112	7	Temperature High Alarm	Set when internal temperature exceeds high alarm level.
112	6	Temperature Low Alarm	Set when internal temperature is below low alarm level.
112	5	Vcc High Alarm	Set when internal supply voltage exceeds high alarm level.
112	4	Vcc Low Alarm	Set when internal supply voltage is below low alarm level.
112	3	TX Bias High Alarm	Set when TX Bias current exceeds high alarm level.
112	2	TX Bias Low Alarm	Set when TX Bias current is below low alarm level.
112	1	TX Power High Alarm	Set when TX output power exceeds high alarm level.
112	0	TX Power Low Alarm	Set when TX output power is below low alarm level.
113	7	RX Power High Alarm	Set when Received Power exceeds high alarm level.
113	6	RX Power Low Alarm	Set when Received Power is below low alarm level.
113	5	Reserved	–
113	4	Reserved	–
113	3	Reserved	–
113	2	Reserved	–
113	1	Reserved	–
113	0	Reserved	–



Table 16 lists descriptions of the Warning Flag bits for the 2-wire interface address A2h, data address 116 and 117.

Table 16. Warning Flags Address – 2-Wire Address 1010001X (OXA2) Addresses 116 and 117

Data Address	Bit	Bit Name	Bit Description
116	7	Temperature High Warning	Set when internal temperature exceeds high warning level.
116	6	Temperature Low Warning	Set when internal temperature is below low warning level.
116	5	Vcc High Warning	Set when internal supply voltage exceeds high warning level.
116	4	Vcc Low Warning	Set when internal supply voltage is below low warning level.
116	3	TX Bias High Warning	Set when TX Bias current exceeds high warning level.
116	2	TX Bias Low Warning	Set when TX Bias current is below low warning level.
116	1	TX Power High Warning	Set when TX output power exceeds high warning level.
116	0	TX Power Low Warning	Set when TX output power is below low warning level.
117	7	RX Power High Warning	Set when Received Power exceeds high warning level.
117	6	RX Power Low Warning	Set when Received Power is below low warning level.
117	5	Reserved	–
117	4	Reserved	–
117	3	Reserved	–
117	2	Reserved	–
117	1	Reserved	–
117	0	Reserved	–



6.6 Masking Alarm and Warning Flag Fields for 2-Wire Interface Address A2h

Table 17 lists descriptions of the Masking Alarm and Warning Flag bits for the 2-wire interface address A2h, data address 136.

Table 17. Masking Alarm and Warning Flags Address– 2-Wire Address A2h, Address 136

Data Address	Bit	Bit Name	Bit Description
136	7	Temp High/Low Alarm/Warning	Masking bit for Temp High/Low Alarm/Warning interrupt source. 0 = Enable 1 = Disable
136	6	Vcc High/Low Alarm/Warning	Masking bit for Vcc High/Low Alarm/Warning interrupt source. 0 = Enable 1 = Disable
136	5	TX Bias High/Low Alarm/Warning	Masking bit for TX Bias High/Low Alarm/Warning interrupt source. 0 = Enable 1 = Disable
136	4	TX Power High/Low Alarm/Warning	Masking bit for TX Power High/Low Alarm/Warning interrupt source. 0 = Enable 1 = Disable
136	3	RX Power High/Low Alarm/Warning	Masking bit for RX Power High/Low Alarm/Warning interrupt source. 0 = Enable 1 = Disable
136	2	Reserved	–
136	1	Reserved	–
136	0	Reserved	–
<p>Note:</p> <ul style="list-style-type: none"> To configure the masking bits at data address location 136 (88h), first set byte 127 (7Fh) of A2h to the value 01h, and then program data address 136 (88h) bits 7 to 3 as needed. (Each of the address 136 bits 7:3 is used to mask out all high/low Alarm and high/low Warning flags.) By default, all Alarm and Warning flags bits are set to '0' (masked out). To unmask an Alarm/Warning flag for any of bits 7:3, use setting '1'. 			

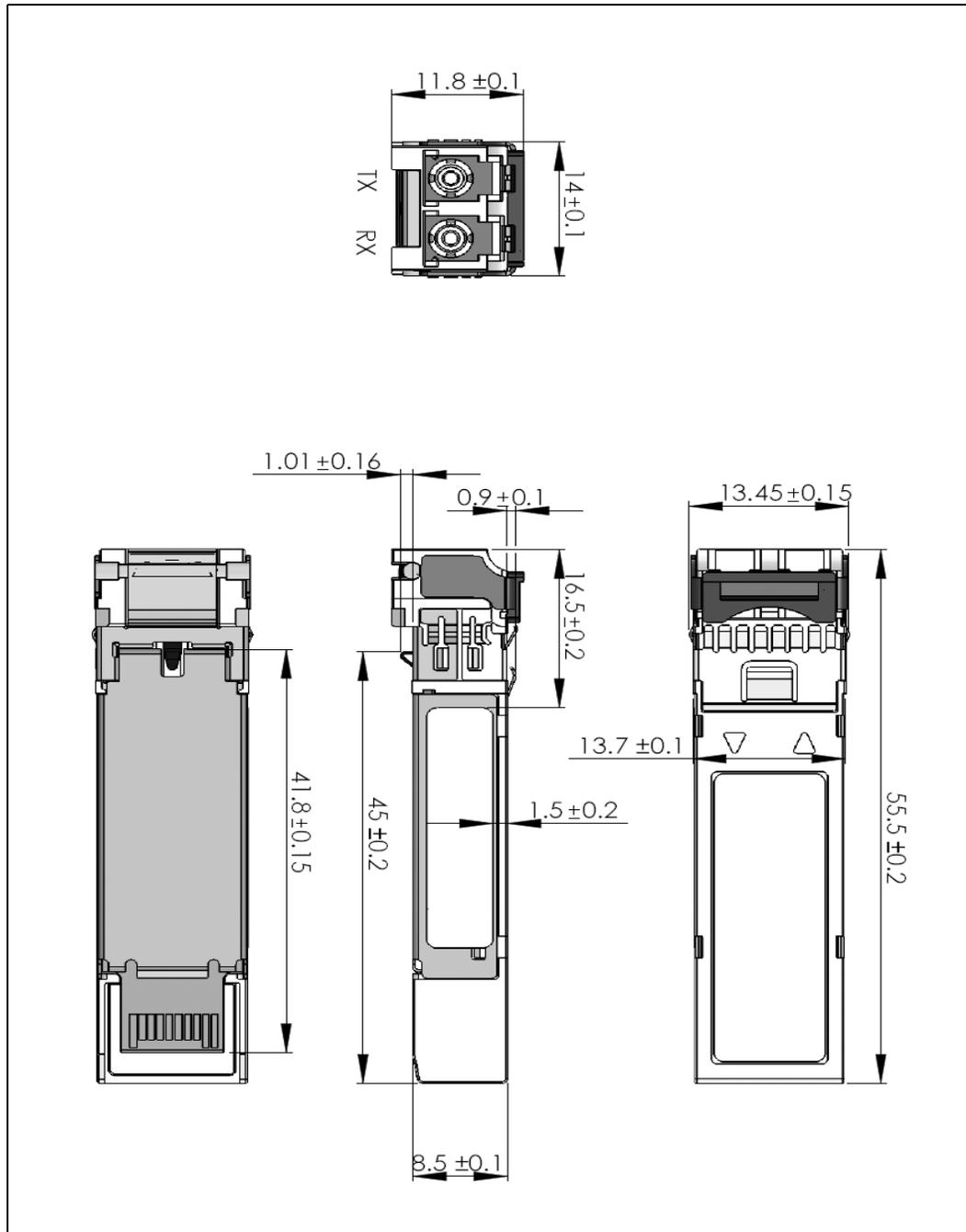


7.0 Mechanical Specifications

Figure 4 shows the TXN22125 4G Optical Transceiver mechanical specifications. The dimensions comply with the SFP MSA.

Note: Aqueous wash is not applicable for the TXN22125 4G Optical Transceiver.

Figure 4. Mechanical Specifications





8.0 Regulatory Compliance

This section discusses the following topics:

- Section 8.1, “Electromagnetic Compatibility Compliance” on page 27
- Section 8.2, “Safety Compliance” on page 28
- Section 8.3, “Lead-Free Conformance” on page 29
- Section 8.4, “Compliance with Restriction of Hazardous Substances” on page 29
- Section 8.5, “Management Methods on Control of Pollution from Electronic Information Products (a.k.a. China RoHS)” on page 30
- Section 8.6, “Product Certification Markings and Compliance Statements” on page 31

8.1 Electromagnetic Compatibility Compliance

Table 18 lists emissions and immunity regulations with which the TXN22125 4G Optical Transceiver complies when tested in a representative chassis.

Table 18. Regulatory Compatibility Compliance

Regulatory Requirement	Applicable Standards	Performance
Electro-Magnetic Interference (EMI)	<ul style="list-style-type: none"> • FCC rules, Part 15, subpart B • EN 55022 	Meets Class B limits with a minimum 6 dB margin
Electro-Static Discharge (ESD)	JEDEC JESD22-A114-B Human Body Model	± 2 kV contact discharge to connector electrical pins with no degradation in performance or loss of function
	EN 61000-4-2	<ul style="list-style-type: none"> • ±15 kV air discharge • ±8 kV contact discharge to face plate Meets Level B test criteria (that is, no degradation of performance or loss of function occurs). Note: Actual ESD may vary, depending on system configuration.
Radio Frequency Electro-Magnetic field (Radiated immunity)	EN 61000-4-3, Level A test criteria	10 V/m from 80 MHz to 1 GHz with no degradation of performance or loss of function



8.2 Safety Compliance

Table 19 lists and describes the relevant safety regulations with which the TXN22125 4G Optical Transceiver complies.

Table 19. Safety Compliance

Requirement	Regulation	Title
Product Safety	UL 60950-1 CSA C22.2 No. 60950-1-03	Information Technology Equipment – Safety - Part 1: General Requirements (USA and Canada)
	EN 60950-1+A11	Information Technology Equipment – Safety - Part 1: General Requirements (European Union)
	IEC 60950-1	Information Technology Equipment – Safety - Part 1: General Requirements (International)
	GR-63-CORE Section 4.2, Clause 4.2.3.1	Compliant with the fire resistance requirements of Telcordia Technologies Generic Requirements GR-63-CORE document for discrete electronic components.
Laser Safety	21CFR1040.10	Title 21 Chapter I Subchapter J – Radiological Health Part 1040: Performance Standards for Light-Emitting Products
	EN 60825-1+A1 +A2	Safety of Laser Products - Part 1: Equipment Classification, Requirements and User's Guide
	IEC 60825-1+A1 +A2	Safety of Laser Products - Part 1: Equipment Classification, Requirements and User's Guide
	EN 60825-2	Safety of Laser Products - Part 2: Safety of Optical Fiber Communication Systems
	IEC 60825-2	Safety of Laser Products - Part 2: Safety of Optical Fiber Communication Systems

Caution: This device is a Class 1 laser product for use only under the recommended operating conditions and ratings specified in this document.



8.3 Lead-Free Conformance

The TXN22125 4G Optical Transceiver uses a lead-free assembly, although certain discrete components within the assembly may contain lead, being necessary for either component performance or reliability. The TXN22125 4G Optical Transceiver is referred to as a "Lead-free 2nd Level Interconnect." The enclosure, circuit board substrate, and the solder connections from the circuit board to the components (second-level connections) are all lead-free.

Table 20 lists various forms of the "Lead-Free 2nd Level Interconnect" marking for the TXN22125 4G Optical Transceiver and accompanying collateral.

Table 20. Lead-Free 2nd-Level Interconnect Markings

Description	Marking
<p>Lead-Free 2nd Level Interconnect: The Lead-Free 2nd Level Interconnect symbol is used to identify electrical and electronic assemblies and components in which the lead (Pb) concentration level in the circuit board substrate and the solder connections from the circuit board to the components (second-level interconnect) are not greater than 0.1% by weight (1000 ppm).</p> <p>Note: Any of the three symbols shown may be used, as space permits.</p>	<div style="text-align: center;">  2nd Level Interconnect </div> <p style="text-align: center;">or</p> <div style="text-align: center;">  2nd lvl Intct </div> <p style="text-align: center;">or</p> <div style="text-align: center;">  2LI </div>

8.4 Compliance with Restriction of Hazardous Substances

This product complies with the European Union directive for Restriction of Hazardous Substances (RoHS) – *Restriction on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment*, Directive 2002/95/EC plus amendments.

However, certain discrete components do contain lead (an RoHS-restricted substance) in amounts that exceed threshold concentration levels. This product uses the following applicable RoHS technology exemptions:

- Lead in optical and filter glass
- Lead in glass of electronic components
- Lead in solders to complete a viable electrical connection between semiconductor die and carrier within integrated circuit Flip Chip packages

Note: RoHS implementation details are subject to change.

This product is RoHS 6 compliant, defined as complying with the restriction for all six listed substances by meeting strict threshold levels for those substances or through the use of the applicable exemptions listed above.



8.5 Management Methods on Control of Pollution from Electronic Information Products (a.k.a. China RoHS)

关于符合中国《电子信息产品污染控制管理办法》的声明

Table 21. Hazardous Substances Table

产品中有毒有害物质的名称及含量

部件名称 (Parts)	有毒有害物质或元素 (Hazardous Substance)					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr(VI))	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
集成光电器件 Integrated optical circuit board assembly	×	○	○	○	○	○
金属盒件 Metal enclosure	○	○	○	○	○	○
<p>○：表示该有毒有害物质在该部件所有均质材料中的含量均在SJ/T 11363-2006标准规定的限量要求以下。</p> <p>○：Indicates that this hazardous substance contained in all homogeneous materials of this part is below the limit requirement in SJ/T 11363-2006.</p> <p>×：表示该有毒有害物质至少在该部件的某一均质材料中的含量超出SJ/T 11363-2006标准规定的限量要求。</p> <p>×：Indicates that this hazardous substance contained in at least one of the homogeneous materials of this part is above the limit requirement in SJ/T 11363-2006.</p> <p>对销售之日的所售产品, 本表显示我公司供应链的电子产品信息产品可能包含这些物质。注意：在所售产品中可能会也可能不会含有所有所列的部件。</p> <p>This table shows where these substances may be found in the supply chain of our electronic information products, as of the date of sale of the enclosed product. Note that some of the component types listed above may or may not be a part of the enclosed product.</p>						
<div style="display: flex; align-items: center;">  <p>除非另外特别的标注, 此标志为针对所涉及产品的环保使用期限标志. 此环保使用期限只适用于产品在产品手册中所规定的条件下工作.</p> <p>The Environment-Friendly Use Period (EFUP) for all enclosed products and their parts are per the symbol shown here, unless otherwise marked. The Environment-Friendly Use Period is valid only when the product is operated under the conditions defined in the product manual.</p> </div>						



8.6 Product Certification Markings and Compliance Statements

Table 22 lists the TXN22125 4G Optical Transceiver product certification markings and compliance statements.

Table 22. Product Certification Markings and Compliance Statements

Origin and Description	Markings and Compliance Statements
Markings	
<p>CE mark. The CE (Conformité Européene*) mark indicates compliance to the European Union Low Voltage directive (2006/95/EC, formerly 73/23/EEC).</p>	
<p>TÜV Rheinland type approval mark for components and subassemblies for the European Union. The Technischer Überwachungsverein* (TÜV – German for “Technical Inspection Association”) Rheinland type approval mark is for components and subassemblies for the European Union. Where space does not permit, the smaller alternate TÜV mark (see the next row in this table) may be used.</p>	
<p>TÜV Rheinland type approval mark for components and subassemblies for the European Union – <i>Alternate</i>. This alternate mark may be used where space constraints exist that do not permit use of the TÜV Rheinland mark in the previous row of this table.</p>	<p>Alternate TÜV mark:</p> 
<p>UL Recognized Component mark for the USA and Canada.</p>	
<p>China Environmental Friendly Use Period (EFUP) mark, where 30 in the marking denotes 30 years.</p>	
Compliance Statements	
<p>USA Food and Drug Administration (FDA), Center for Devices and Radiological Health compliance statement.</p>	<p>Complies with 21CFR 1040.10 except for deviations pursuant to Laser Notice No. 50, dated July 26, 2001.</p>
<p>USA FDA, Center for Devices and Radiological Health compliance statement – <i>Alternate</i>. Use the alternate statement listed, as needed.</p>	<p>Alternate FDA compliance statement: Complies with FDA performance standards for laser products except for deviations pursuant to Laser Notice No. 50, dated July 26, 2001.</p>



9.0 Ordering Information

Table 23 lists ordering information for the TXN22125 4G Optical Transceiver.

Table 23. Ordering the Intel® TXN22125 4G Optical Transceiver

Part Number	MM Number	Description
TXN22125D000xxx ¹	867394	4 Gbps Fibre Channel single mode 10km SFP module with digital diagnostics feature with RoHS 6.
1. The last three characters of the part number ("xxx") are used to designate customer-specific customizations. The Intel standard part has "000" as the last three characters.		



10.0 Acronyms

Table 24. Acronyms

Acronym	Meaning
ASCII	American Standard Code for Information Interchange
BER	Bit Error Rate
BR	Bit Rate
CFR	Code of Federal Relations
CML	Current Mode Logic
EEPROM	Electrically Erasable Programmable Read Only Memory
EMI	Electro-Magnetic Interference
ESD	Electro-Static Discharge
EU	European Union
FC-PI	Fibre Channel – Physical Interfaces
FCC	Federal Communications Commission
FDA	Food and Drug Administration
GBIC	GigaBit Interface Converter
Gbps	Gigabits per second
IEC	International Electrotechnical Commission
IEEE	Institute of Electrical and Electronics Engineers
LOS	Loss of Signal
MSA	Multisource Agreement
OUI	Organizationally Unique Identifier
PRBS	Pseudo Random Bit Sequence
RoHS	Restriction of Hazardous Substances
SerDes	Serializer/Deserializer
SFF	Small-Form Factor
SFP	Small-Form Factor Pluggable
SMF	Single-Mode Fiber
TTL	Transistor-Transistor Logic
UL	Underwriter Laboratories

§ §



Intel® TXN22125 4G FC 1310 nm SFP 10 km Optical Transceiver - SFP MSA Compatible*